

Docket No.: 062807-0334

04-11-2006

U.S. DEPARTMENT OF COMMERCE  
Patent and Trademark Office

103216204

To the Honorable Commissioner for Patent,

Please record the attached original documents or copy thereto:

## 1. Name of Conveying Party(ies):

**Hiromi INADA, Hiroyuki TANAKA, Shun-ichi WATANABE,  
Shigeto ISAKOZAWA, Mitsugu SATO, Atsushi TAKANE,  
Satoshi YAMAGUCHI**Additional name(s) of conveying party(ies) attached? ☐ Yes ☐ No

## 2. Name and address of receiving party(ies):

Name: **HITACHI HIGH-TECHNOLOGIES  
CORPORATION**Address: **24-14, Nishishinbashi 1-chome,  
Minato-ku,  
Tokyo, JAPAN**

## 3. Nature of Conveyance:

- ☒ Assignment ☐ Merger  
☐ Security Agreement ☐ Change of Name  
☐ Other

Execution Date: **March 15, 2006, March 16, 2006, March 15,  
2006, March 15, 2006, March 15, 2006, March  
15, 2006, March 20, 2006 (resepctively)**Additional name(s) & address(es) attached? ☐ Yes ☐ No

## 4. Application number(s) or patent number(s):

If the document is being filed together with a new application,  
the execution date of the application is:

March 15, 2006	March 16, 2006	March 15, 2006
March 15, 2006	March 15, 2006	March 15, 2006
March 20, 2006	(resepctively)	

A. Patent Application No(s).

B. Patent No(s).

Additional numbers attached? ☐ Yes ☐ No5. Name and address of party to whom correspondence  
concerning document should be mailed:Name: **MCDERMOTT WILL & EMERY LLP**

Internal Address:

Street Address: **600 13th Street, N.W.**City: **Washington** State: **D. C.** Zip: **20005-3096**

## 6. Total number of applications and patents involved: 1

## 7. Total fee (37 CFR 3.41)

\$40.00

- ☐ Enclosed  
☒ Authorized to be charged to deposit account

## 8. Deposit account number:

500417

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## 9. Statement and signature.

*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy  
of the original document.*

Keith E. George, Registration No. 34,111

Name and Registration No. of Person Signing

Signature

April 2006

Date

Total number of pages including cover sheet:

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04/11/2006

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**ASSIGNMENT**  
( 譲渡証 )

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi High-Technologies Corporation, a corporation organized under the laws of Japan, located at 24-14, Nishishinbashi 1-chome, Minato-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi High-Technologies Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

CHARGED PARTICLE BEAM EQUIPMENT

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Hitachi High-Technologies Corporation, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi High-Technologies Corporation.

Signed on the date(s) indicated aside signatures:

INVENTOR(S)  
(発明者フルネームサイン)

Date Signed  
(署名日)

1)	<u>Hiromi Inada</u> Hiromi INADA	<u>Mar. 15, 2006</u>
2)	<u>Hiroyuki Tanaka</u> Hiroyuki TANAKA	<u>Mar. 16, 2006</u>
3)	<u>Shun-ichi Watanabe</u> Shun-ichi WATANABE	<u>Mar. 15, 2006</u>
4)	<u>Shigeto Isakozawa</u> Shigeto ISAKOZAWA	<u>Mar 15, 2006</u>
5)	<u>Mitsugu Sato</u> Mitsugu SATO	<u>15/03/2006</u>
6)	<u>Atsushi Takane</u> Atsushi TAKANE	<u>15/03/2006</u>
7)	<u>S. Yamaguchi</u> Satoshi YAMAGUCHI	<u>20/03/2006</u>
8)	_____	_____
9)	_____	_____
10)	_____	_____

PATENT

RECORDED: 04/04/2006

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